

**IN THE UNITED STATES PATENT  
AND TRADEMARK OFFICE**

Applicants: JUNG et al.	)	For: "Methods of Manufacturing a
	)	Semiconductor Device"
Serial No.: To be assigned	)	
	)	Group Art Unit: To be determined
Filed: November 25, 2003	)	
	)	Examiner: To be determined

**INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The patents and/or publications listed on the enclosed PTO Form-1449 are submitted pursuant to 37 CFR §§ 1.56, 1.97, and 1.98. Copies of the patents or publications are enclosed.

This information disclosure statement is being filed with the application. Therefore, in accordance with 37 CFR §1.97(b), no certification or fee is required.

The Commissioner is authorized to charge any fee deficiency required by this paper to Deposit Account No. 50-2455. A copy of this paper is enclosed.

Correspondence Address:

Respectfully submitted,

GROSSMAN & FLIGHT, LLC.  
20 N. Wacker Drive  
Suite 4220  
Chicago, Illinois 60606  
(312) 580-1020

By:

  
James A. Flight  
Registration No.: 37,622

November 25, 2003

Form PTO-1449 (Modified)

U.S. Department of Commerce  
Patent and Trademark OfficeAtty. Docket No.  
20061/OF03P197Serial No.  
To be assigned**INFORMATION DISCLOSURE STATEMENT***(Use several sheets if necessary)*Applicant  
JUNG et al.Filing Date  
11/25/03Group Art Unit  
To be determined**U.S. PATENT DOCUMENTS**

*EXAMINER INITIALS		DOCUMENT NUMBER	ISSUE DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	A01	6,255,217	7/3/01	Agnello et al.	438	687	
	A02	6,211,085	4/3/01	Liu	438	687	
	A03						

**FOREIGN PATENT DOCUMENTS**

*Examiner Initials		Document Number	Publication Date	Country	Class	Subclass	Translation	
	B01						Yes	No
	B02							

**OTHER DOCUMENTS** (Including Author, Title, Date, Pertinent Pages, etc.)

	C01	
	C02	

**EXAMINER****DATE CONSIDERED**

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.